Silicon Carbide Schottky Diode



VRRM =	1200 V
 F (Tc = 135°C) =	71 A
Qc =	267 nC

Features

Advantages

- Low V_F for High Temperature Operation
- Enhanced Surge and Avalanche Robustness
- Superior Figure of Merit Q_C/I_F
- Low Thermal Resistance
- Low Reverse Leakage Current
- Temperature Independent Fast Switching
- Positive Temperature Coefficient of V_F
- High dV/dt Ruggedness

Improved System EfficiencyHigh System Reliability

• Optimal Price Performance

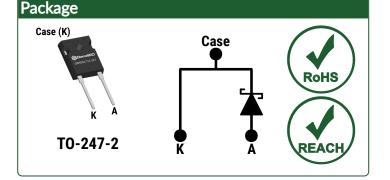
Reduced Cooling Requirements

Zero Reverse Recovery Current

• Increased System Power Density

Enables Extremely Fast Switching

• Easy to Parallel without Thermal Runaway



Applications

- Electric Vehicles and Fast Chargers
- Solar Inverters
- Train Auxiliary Power Supplies
- High frequency Converters
- Motor Drives
- Induction Heating and Welding
- Uninterruptible Power Supplies
- Pulsed Power

Absolute Maximum Ratings (At Tc = 25°C Unless Otherwise Stated)

Parameter	Symbol	Conditions	Values	Unit	Note
Repetitive Peak Reverse Voltage	V _{RRM}		1200	V	
		T _C = 100°C, D = 1	102		
Continuous Forward Current	IF	I _F T _C = 135°C, D = 1		А	Fig. 4
		T _C = 152°C, D = 1	50		
Non-Repetitive Peak Forward Surge Current, Half Sine	Irou	T _C = 25°C, t _P = 10 ms	500	А	
Wave	IF,SM	Tc = 150°C, t⊵ = 10 ms	400	A	
Ponetitive Deak Forward Surge Current Half Sine Wave	lenu	T _C = 25°C, t _P = 10 ms	300	А	
Repetitive Peak Forward Surge Current, Half Sine Wave	IF,RM	Tc = 150°C, t⊵ = 10 ms	210	A	
Non-Repetitive Peak Forward Surge Current	I _{F,MAX}	T _C = 25°C, t _P = 10 μs	2500	Α	
i ² t Value	∫i²dt	T _C = 25°C, t _P = 10 ms	1250	A ² s	
Non-Repetitive Avalanche Energy	E _{AS}	L = 0.7 mH, I _{AS} = 50 A	899	mJ	
Diode Ruggedness	dV/dt	V _R = 0 ~ 960 V	200	V/ns	
Power Dissipation	Ртот	T _C = 25°C	629	W	Fig. 3
Operating and Storage Temperature	T _j , T _{stg}		-55 to 175	°C	

GB50SLT12-247 1200V 50A SiC Schottky MPS™ Diode



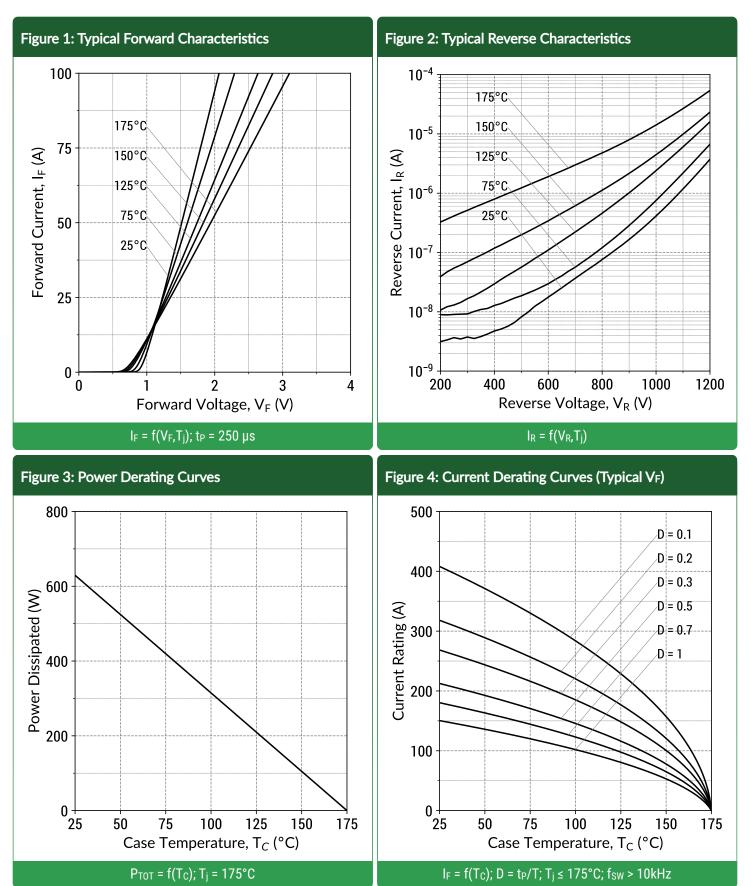
Electrical Characteristics

Deveneter	Cumhal	Conditions		Values			11	Nete
Parameter	Symbol			Min.	Тур.	Max.	Unit	Note
Diode Forward Voltage	V _F	I _F = 50 A, T _j = 25°C			1.5	1.8	۷	Fig. 1
	۷F	I _F = 50 A, T _j = 175°C			1.9			
Reverse Current	la la	V _R = 1200 V, T _j = 25°C			4	20		Fig. 2
	I _R	V _R = 1200 V, T _j = 175°C			54		μA	
Total Capacitive Charge	Qc		V _R = 400 V		184		nC	Fig. 7
	QC	I _F ≤ I _{F,MAX}	V _R = 800 V		267			
Switching Time	+-	dl _F /dt = 200 A/μs V _R = 400 V V _R = 800 V			< 10		20	
	ts			< 10			ns	
Total Capacitance	C	V _R = 1 V, f = 1MHz			3046			Fig. 6
	С	V _R = 800 V, f = 1MHz			178	pF		

Thermal/Package Characteristics

overneter Cumbel		Conditions	Values			11	Note
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit	Note
Thermal Resistance, Junction - Case	RthJC			0.24		°C/W	Fig. 9
Weight	WT			6.0		g	
Mounting Torque	TM	Screws to Heatsink			1.1	Nm	

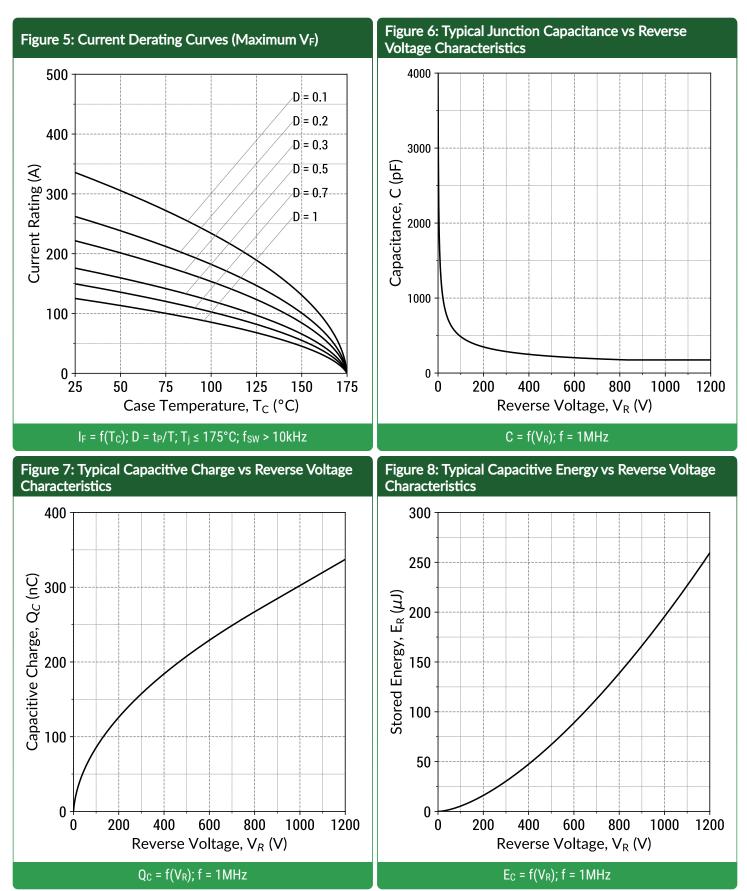




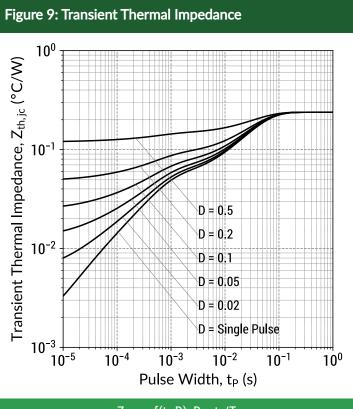
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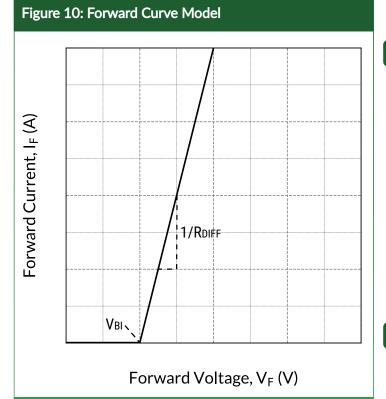




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 $Z_{th,jc} = f(t_P,D); D = t_P/T$



$I_F = f(V_F,T_j)$



Forward Curve Model Equation:

 $I_F = (V_F - V_{BI})/R_{DIFF} (A)$

Built-In Voltage (V_{BI}):

 $V_{BI}(T_j) = m \times T_j + n (V)$ m = -0.00123 (V/°C) n = 0.995 (V)

Differential Resistance (RDIFF):

 $R_{DIFF}(T_j) = a \times T_j^2 + b \times T_j + c (\Omega)$ a = 2.38e-07 (\Omega/°C^2) b = 3.38e-05 (\Omega/°C) c = 0.01 (\Omega)

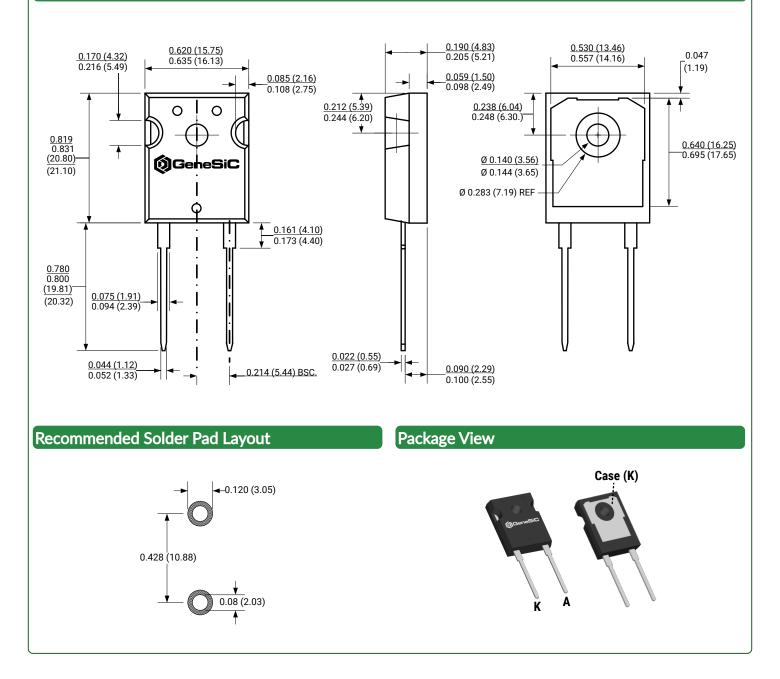
Forward Power Loss Equation:

 $P_{LOSS} = V_{BI}(T_j) \times I_{AVG} + R_{DIFF}(T_j) \times I_{RMS}^2$



Package Dimensions

TO-247-2 Package Outline



NOTE

- 1. CONTROLLED DEIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
- 2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS.

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RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS 2), as adopted by EU member states on January 2, 2013 and amended on March 31, 2015 by EU Directive 2015/863. RoHS Declarations for this product can be obtained from your GeneSiC representative.

REACH Compliance

REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a GeneSiC representative to insure you get the most up-to-date REACH SVHC Declaration. REACH banned substance information (REACH Article 67) is also available upon request.

This product has not been designed or tested for use in, and is not intended for use in, applications implanted into the human body nor in applications in which failure of the product could lead to death, personal injury or property damage, including but not limited to equipment used in the operation of nuclear facilities, life-support machines, cardiac defibrillators or similar emergency medical equipment, aircraft navigation or communication or control systems, or air traffic control systems.

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Related Links

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